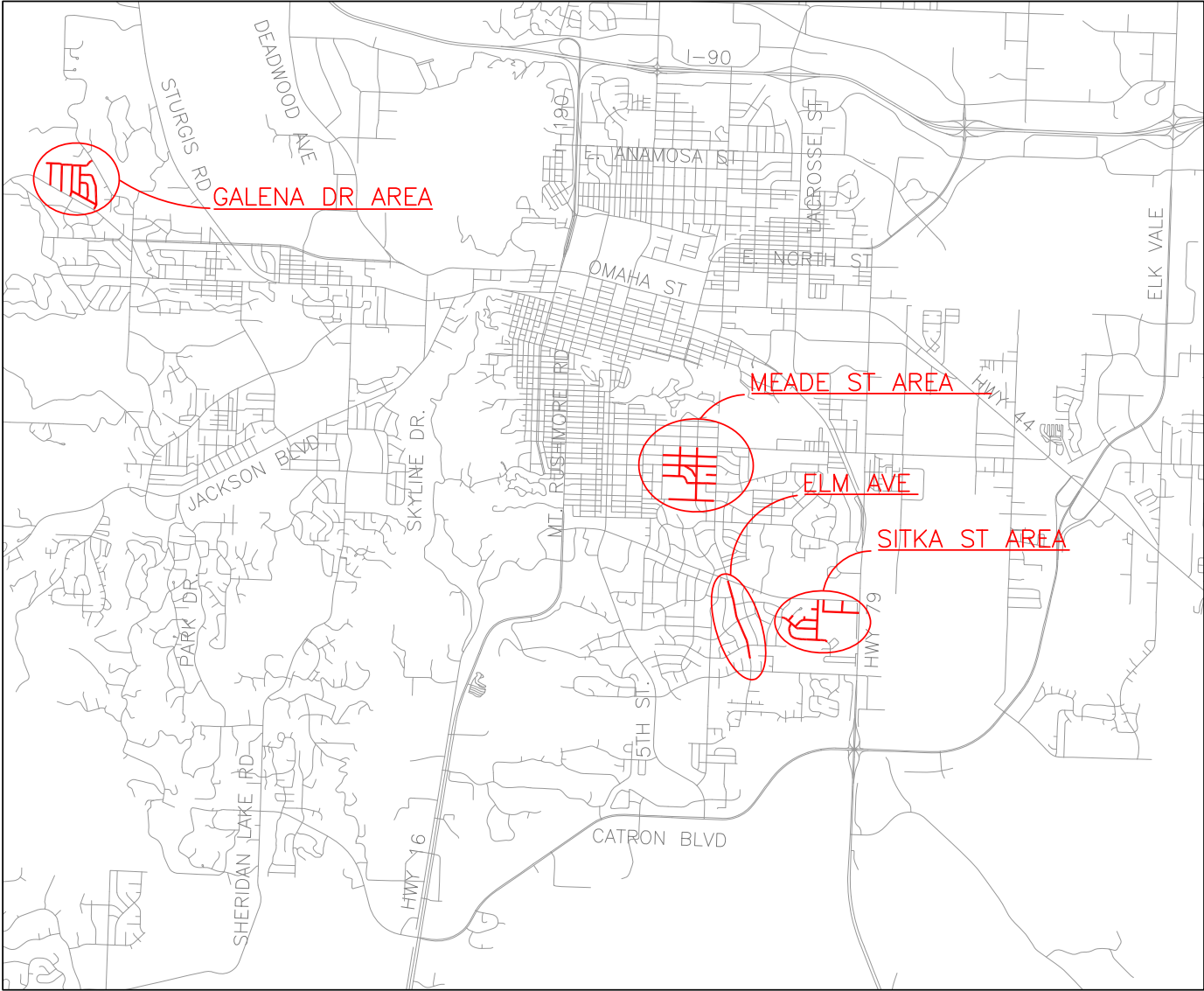


VICINITY MAP



**2018 CHIP SEALING PROJECT
PROJECT # 18-2436, CIP 50844**